

1.6x0.6mm RIGHT ANGLE SMD CHIP LED **LAMP**



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE DEVICES

Part Number: APA1606SECK

Super Bright Orange

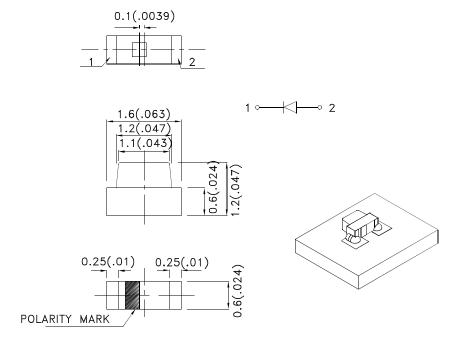
Features

- 1.6mmx1.2mmx0.6mm right angle SMD LED,0.6mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package :2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Descriptions

- The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



- All dimensions are in millimeters (inches).
 Tolerance is ±0.1(0.004") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Part No. Emitting Color (Material) Lens Typ		lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
ADA4606SECK	Super Bright Orange (AlGalnP)	Water Clear	110	250	- 110°
APA1606SECK			*80	*180	

Notes:

- 1. θ 1 / 2 is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
- 2. Luminous intensity / luminous Flux: + / -15%.

 * Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Liectifical 7 Optical Characteristics at 1A-20 C									
Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions			
λpeak	Peak Wavelength	Super Bright Orange	610		nm	IF=20mA			
λD [1]	Dominant Wavelength	Super Bright Orange	601		nm	IF=20mA			
Δλ1/2	Spectral Line Half-width	Super Bright Orange	29		nm	IF=20mA			
С	Capacitance	Super Bright Orange	15		pF	VF=0V;f=1MHz			
VF [2]	Forward Voltage	Super Bright Orange	2.1	2.5	V	IF=20mA			
lr	Reverse Current	Super Bright Orange		10	uA	V _R =5V			

Notes:

- 1. Wavelength: + / -1nm.
- 2. Forward Voltage: + / -0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

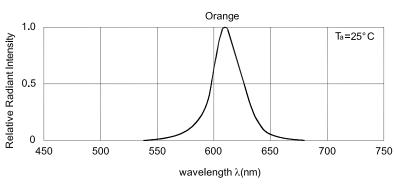
Absolute maximum Natings at 1A 20 0					
Parameter	neter Values				
Power dissipation	75	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	195	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C	-40°C To +85°C			
Storage Temperature	-40°C To +85°C	-40°C To +85°C			

Notes:

- 1.1/10 Duty Cycle, 0.1ms Pulse Width.
 Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

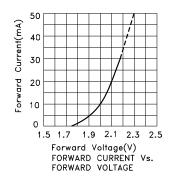
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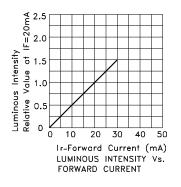
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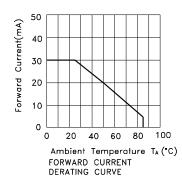


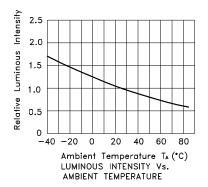
Relative Intensity Vs. Wavelength

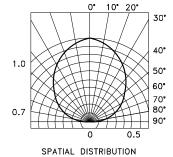
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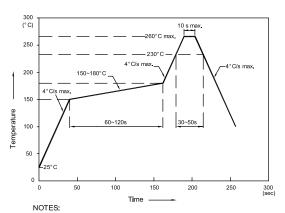
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



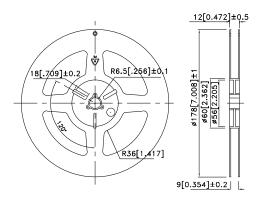
- 1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

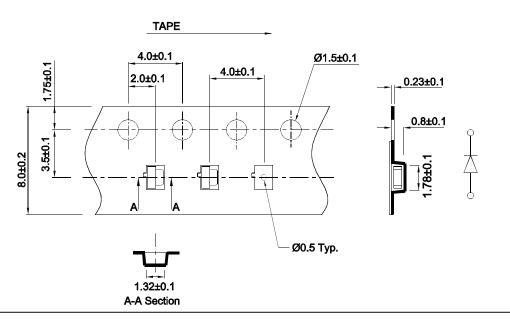
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

0.9

Tape Dimensions (Units: mm)

Reel Dimension



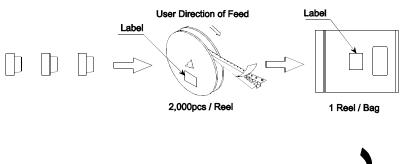


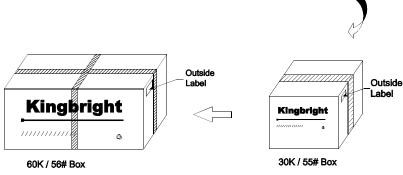
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PACKING & LABEL SPECIFICATIONS

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